DERWENT-ACC-NO: 1990-239666

DERWENT-WEEK: 199840

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TITLE: High temp. ceramic heating element for automotives - consists of aluminium nitride substrate with doped areas to reduce heat loss and printed

metallic conductor

INVENTOR: GRUENWALD, W; KRANZMANN, A; MUEHLEDER, F

PATENT-ASSIGNEE: BOSCH GMBH ROBERT[BOSC]

PRIORITY-DATA: 1989DE-3901545 (January 20, 1989)

PATENT-FAMILY:

PUB-NO	PUB-DATE	LANGUAGE
PAGES MA		
DE 3901545 A	August 2, 1990	N/A
007 N/A	A	
JP 2792981 B2	September 3, 1998	N/A
006 но	5B 003/16	
FR 2642116 A	July 27, 1990	N/A
000 N/A	P	
DE 3901545 C	April 18, 1991	N/A
000 N/A	F	
JP 03196484 A	August 27, 1991	N/A
000 N/A	F	
IT 1237957 B	June 19, 1993	N/A
000 F02	2N 000/00	

APPLICATION-DATA:

PUB-NO		APPL-DESCRIPTOR		APPL-NO	
	APPL-DAT	ΓE			
DE	3901545A		N/A		1989DE-3901545
	January	20,	1989		
JΡ	2792981B2		N/A		1990JP-0008560
	January	19,	1990		
JΡ	2792981B2		Previous	Publ.	JP 3196484
	N/A				
FR	2642116A		N/A		1990FR-0000684
	January	22,	1990	•	
JΡ	03196484A		N/A	•	1990JP-0008560

January 19, 1990 IT 1237957B N/A January 16, 1990

1990IT-0019075

INT-CL (IPC): B41M001/34; C04B035/58; C04B035/581;

F02N000/00; F02P019/00; F23Q007/00; H05B003/16

ABSTRACTED-PUB-NO: DE 3901545A
BASIC-ABSTRACT: The AlN substrate supports a heating conductor and contains regions of reduced thermal conductivity caused by doping with foreign ions, pref. Si, pref. in a concn. range from 50 ppm to 5%. The heaters are mfd. by first doping the AlN substrate where low conductivity is required, then

printing the heating track pattern and finally sintering the construction in a shielding gas ambient.

Substrate doping can be carried out by printing a paste containing the foreign ions or depositing them by evaporation in the appropriate areas and heating the substrates to cause diffusion, pref. 12-36 hrs in vacuum or shielding gas at 800-1400 deg.C. Also claimed is the addition of dopant, pref. Si, to the heating element paste. The AlN substrates can be , wafers or rods.

USE/ADVANTAGE - The doping of AlN allows retention of the superior properties of AlN such as good adhesion of the heater material, good thermal shock performance and hardness while reducing the thermal conductivity.

ABSTRACTED-PUB-NO: DE 3901545C
EQUIVALENT-ABSTRACTS: Electrical high temp. heating element comprises an Al nitride substrate (I), on which is applied a thick layer heat conductor and a heat-conducting housing which partly surrounds (I). The improvement is that the part of (I) which is in the housing is doped with 0.35%

to 5% of foreign ions, which reduce the thermal conductivity of the Al nitride. Pref. O and/or B and/or Si ions are used as doping materials. ADVANTAGE - The heat conduction, from the heater area in the edge zones, esp. towards the contacting (mounting) is predominantly inhibited.

(7pp)

CHOSEN-DRAWING: Dwg.1/3

TITLE-TERMS:

HIGH TEMPERATURE CERAMIC HEAT ELEMENT AUTOMOTIVE CONSIST ALUMINIUM NITRIDE SUBSTRATE DOPE AREA REDUCE HEAT LOSS PRINT METALLIC CONDUCTOR

DERWENT-CLASS: L03 P75 Q54 Q73 X22 X25

CPI-CODES: L02-J01A; L03-H04A;

EPI-CODES: X22-A02B; X22-A09; X25-B01B;

SECONDARY-ACC-NO:

CPI Secondary Accession Numbers: C1990-103645 Non-CPI Secondary Accession Numbers: N1990-185941

02/25/2003, EAST Version: 1.03.0002

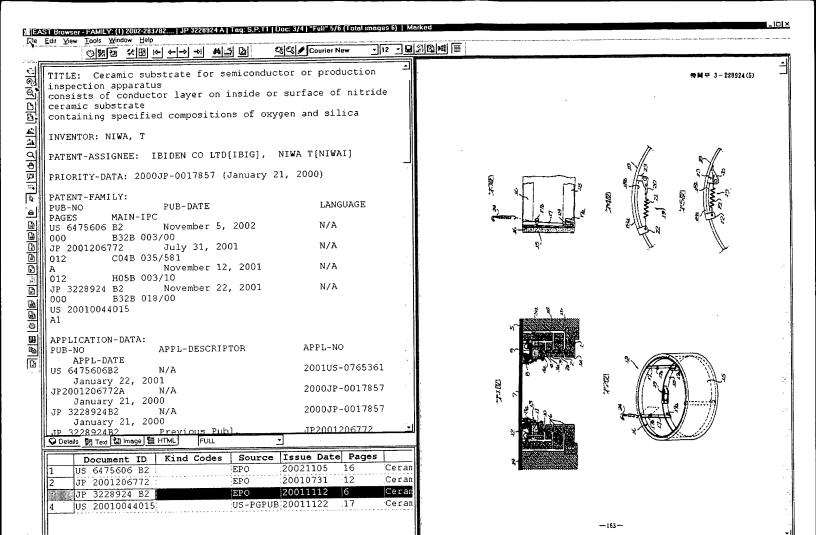
page 1/1

No. | Publication No.

Title

- 1. 03 267061(1991) CONTAINER FOR TREATMENT OF USED MEDICAL SYRINGE
- 2. 03 009503(1991) EXCITING COIL USED IN A VACUUM
- 3. 01 180261(1989) WATER-COOLED NOZZLE
- 4. 01 180227(1989) AGITATING ELECTRIC MOTOR FOR HERMETIC VESSEL
- 5. 62 265738(1987) MOUNT FOR MEASURING WAFER WITHOUT DEWING OR ICING EVEN IN LOW TEMPERATURE RANGE

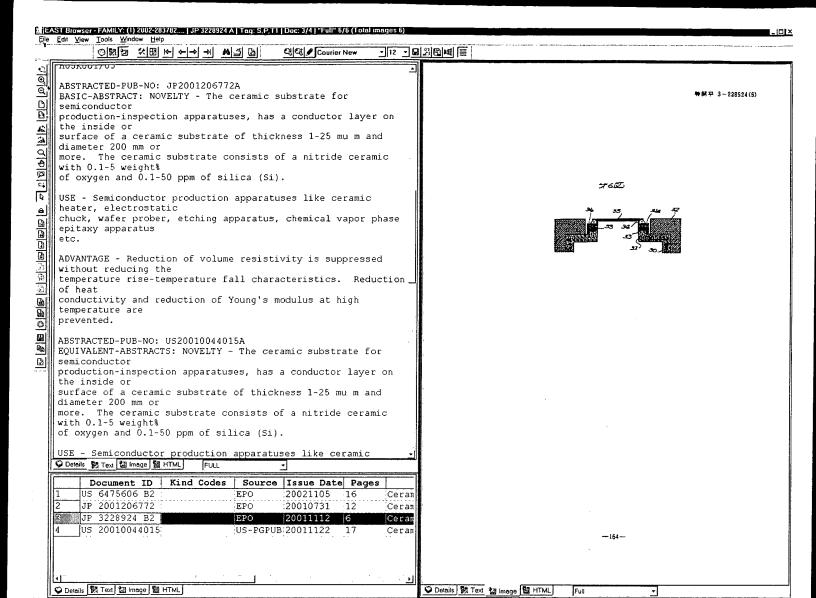
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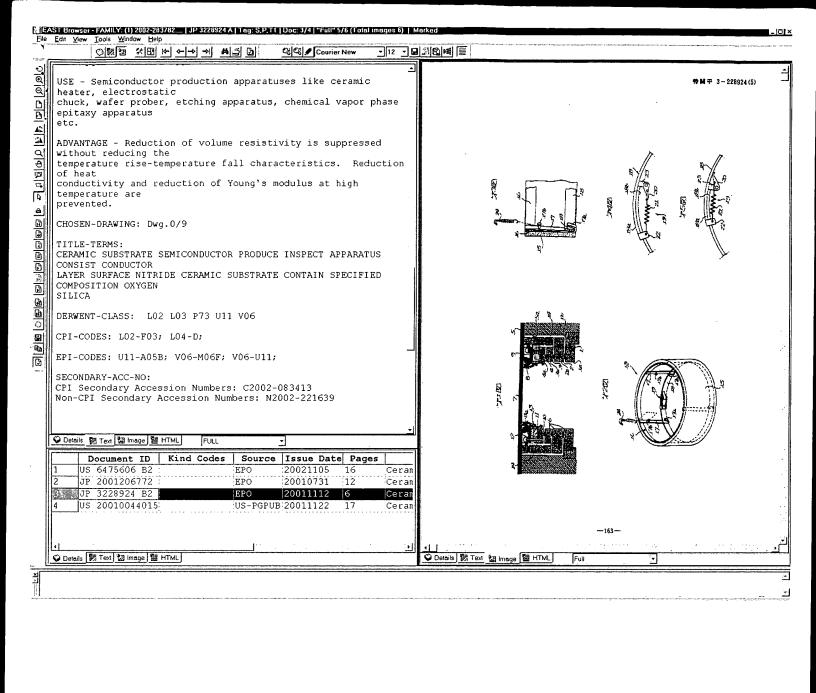


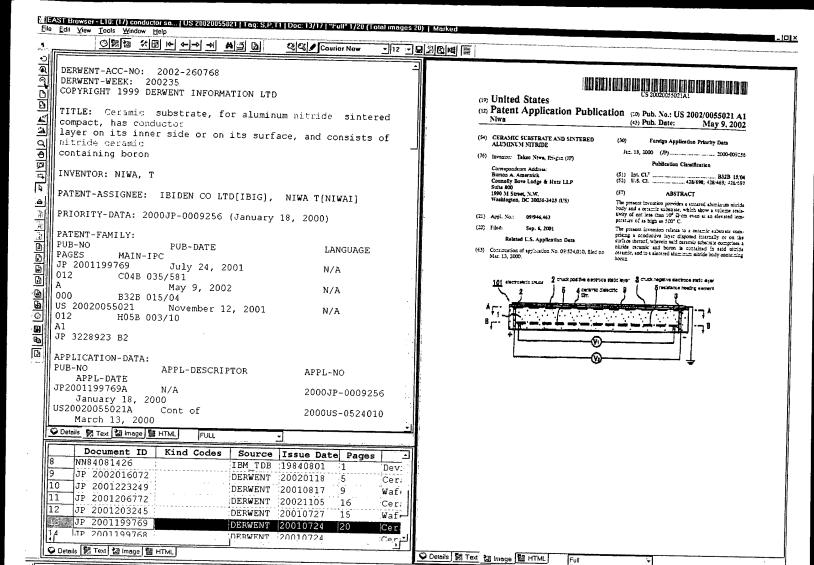
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